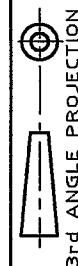


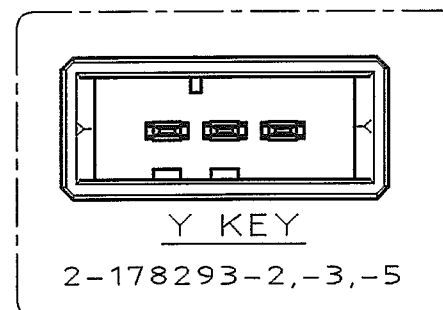
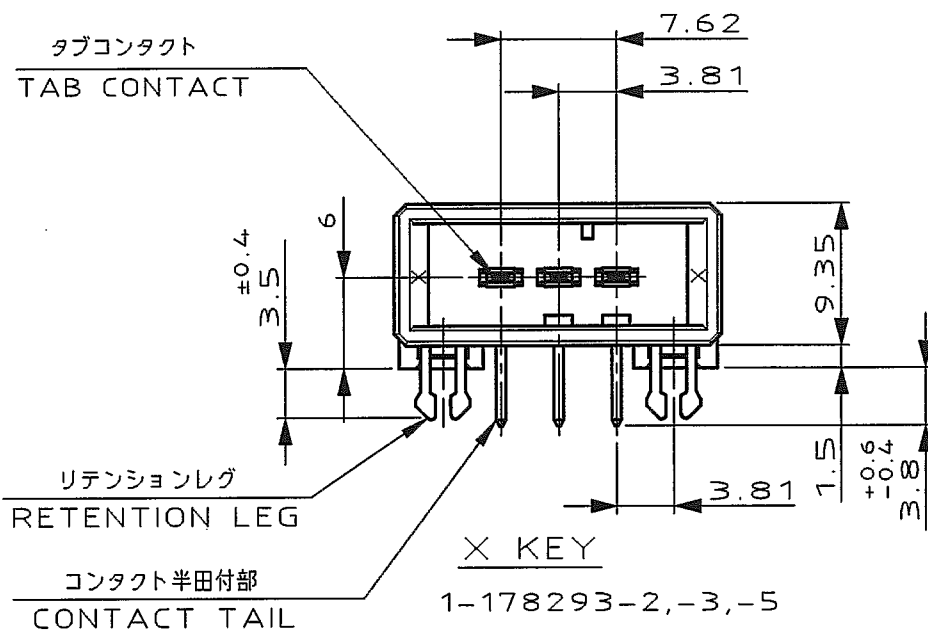
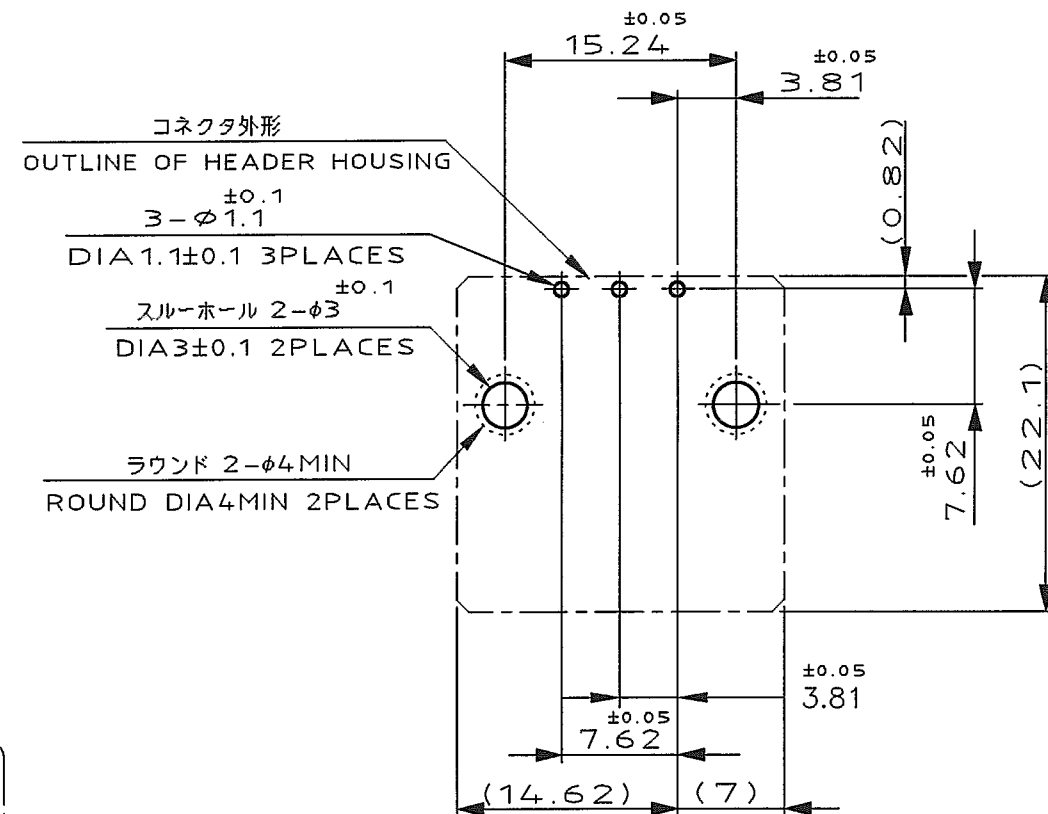
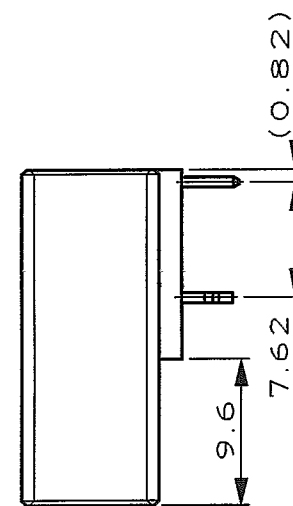
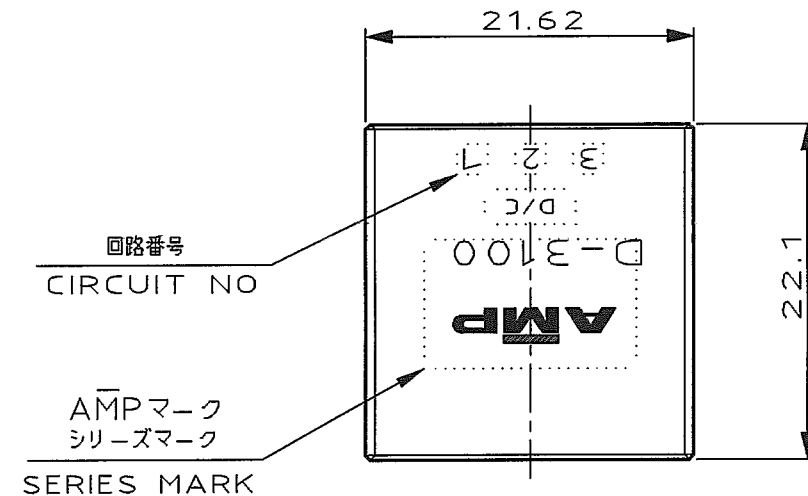
NUMBER 178293



METRIC

DIMENSIONS IN MILLIMETERS. DO NOT SCALE PRINT

PRINT DIST



推奨基板取付け穴寸法

PC 基板厚: 1.6±0.1
(非累積公差)
(コネクタ搭載面)

RECOMEND PC BOARD HOLE PATTERN

PC BOARD THICKNESS: 1.6±0.1
(NOT ACCUMULATE TOLERANCE)
(CONNECTOR MOUNT SIDE)

NOTES

1. MATERIAL: HOUSING: GLASS FILLED THERMO PLASTIC, POLYESTER

CONTACT: COPPER ALLOY

RETENTION LEG: COPPER ALLOY

2. FINISH (CONTACT AREA): 0.38μm PdNi & Au PLATING OVER NICKEL

3. FINISH (CONTACT AREA): 0.76μm PdNi & Au PLATING OVER NICKEL

4. FINISH (CONTACT AREA): 2.0 μm MIN TIN PLATED OVER NICKEL

5. FINISH (RETENTION LEG): TIN-LEAD PLATED (CONTACT TAIL) OVER NICKEL

6. FINISH (RETENTION LEG): TIN PLATED (CONTACT TAIL) OVER NICKEL

6	4	1,2-178293-5
6	3	1,2-178293-3
6	2	1,2-178293-2
(FINISH)		製品番号 (PART NO.)

D	REVISED PER ECR-25-250788	F.Z	R.B	16 JAN 2025
C1	REVISED PER ECO-11-005030	RK	HMR	14 APR 11
LTR	REVISION RECORD	DR	CHK	DATE

WIRE RANGE	INSULATION DIA	NAME
mm (AWG)	mm	
MATERIAL	FINISH	
SEE NOTE	SEE NOTE	
DR. 20/MAR/'95	DE. 20/MAR/'95	
K.IKEDA	K.IKEDA	
CHK. 23/MAR/'92	APP. 23/MAR/'92	
S. MANABE	S. MANABE	

3 POS SINGLE ROW HORIZONTAL HDR ASS'Y FOR DYNAMIC 3100			
一般公差 (GENERAL TOLERANCE)	SIZE	LOC	NUMBER
10mm以下 : ±0.3 10mm以上 3mm以下 : ±0.4 30mm以上 100mm以下 : ±0.5 角 度 : ±3°	A3	J	C-178293
SCALE	REV.	D	SHEET
2-1			1 OF 1



(CUSTOMER DRAWING) 顧客用図面